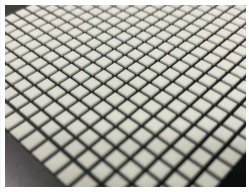
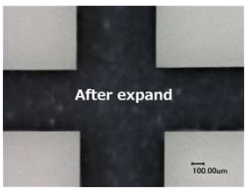
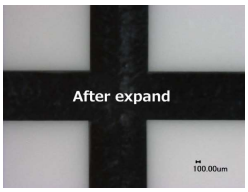
WORKS

<< Ceramics >>

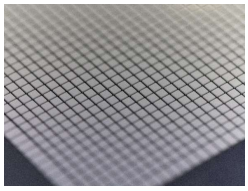
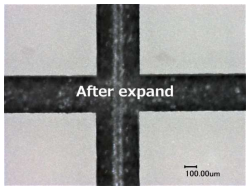
Material	Alumina (Al_2O_3)
Thickness	t0.635 mm
Substrate size	□50x50 mm
Chip size	□2.5x2.5 mm

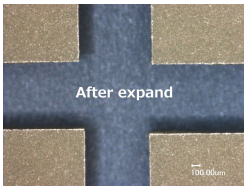
Material	Alumina (Al_2O_3)
Thickness	t2.0 mm
Substrate size	□50x50 mm
Chip size	□10x10 mm



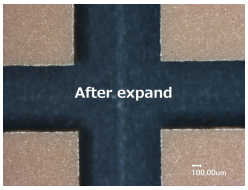
Material	Zirconia (YSZ)
Thickness	t0.3 mm
Substrate size	□50x50 mm
Chip size	□1.5x1.5 mm

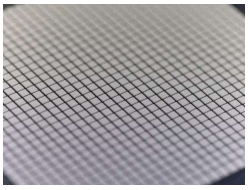
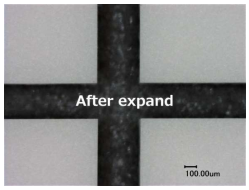
Material	Dielectric (εr:134)
Thickness	t0.635 mm
Substrate size	□50x50 mm
Chip size	□5x5 mm



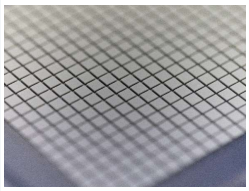
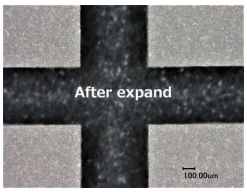
Material	Dielectric (εr:20.5)
Thickness	t0.635 mm
Substrate size	□50x50 mm
Chip size	□5x5 mm



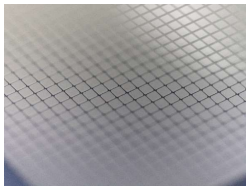
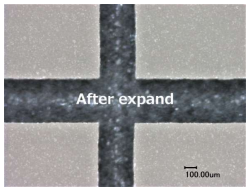
Material	LTCC
Thickness	t0.3 mm
Substrate size	□50x50 mm
Chip size	□1.5x1.5 mm

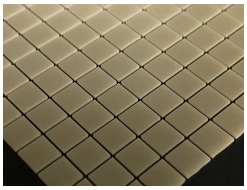
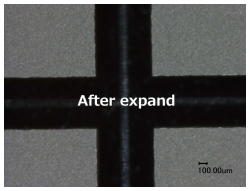
Material	Silicon nitride (Si_3N_4)
Thickness	t0.3 mm
Substrate size	□50x50 mm
Chip size	□2.5x2.5 mm

Material	Aluminum nitride (AlN)
Thickness	t0.3 mm
Substrate size	□50x50 mm
Chip size	□1.5x1.5 mm

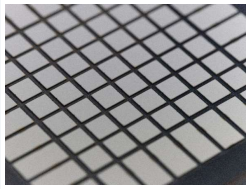
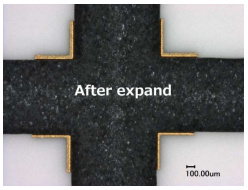



Material	Aluminum nitride (AlN)
Thickness	t0.635 mm
Substrate size	□50x50 mm
Chip size	□5x5 mm

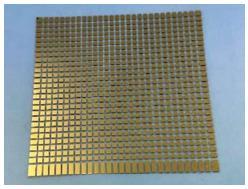
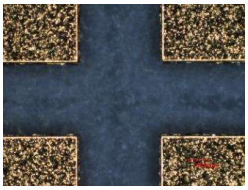



<< Ceramics (Metalize) >>

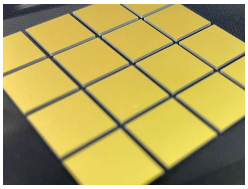
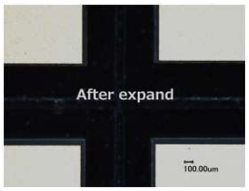
Material	Alumina-metalize-
Thickness	t0.25 mm
Substrate size	□50x50 mm
Chip size	□5x5 mm

Material	AlN-metalize-
Thickness	t0.15 mm
Substrate size	□30x30 mm
Chip size	□1x1 mm

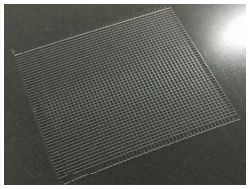
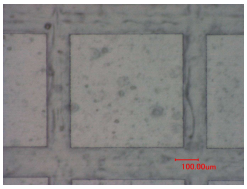
Material	Alumina-metalize-
Thickness	t0.635 mm
Substrate size	□40x40 mm
Chip size	□10x10 mm

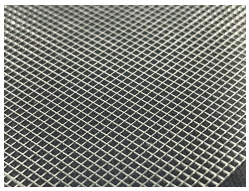
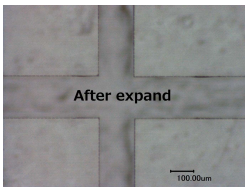
WORKS

<< Glasses >>

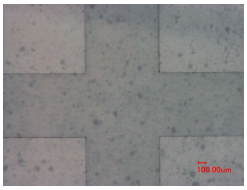
Material	Glass (D263)
Thickness	t0.1 mm
Substrate size	□25x25 mm
Chip size	□0.5x0.5 mm

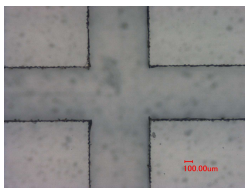
Material	Glass
Thickness	t0.3 mm
Substrate size	□50x50 mm
Chip size	□1.0x1.0 mm

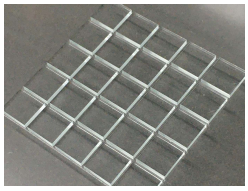
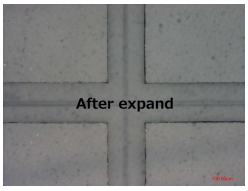
Material	Glass (D263)
Thickness	t0.4 mm
Substrate size	□50x50 mm
Chip size	□5x5 mm



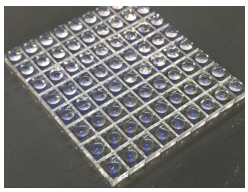
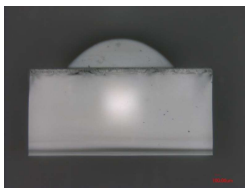
Material	Glass (D263)
Thickness	t1.1 mm
Substrate size	□50x50 mm
Chip size	□5x5 mm



Material	Glass (Soda-lime)
Thickness	t1.8 mm
Substrate size	□50x50 mm
Chip size	□10x10 mm

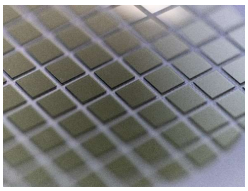
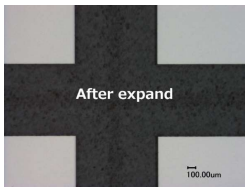



Material	Glass
Thickness	t2.4 mm
Lens height	t0.8 mm
Chip size	□3.8x4.8 mm

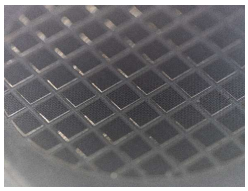
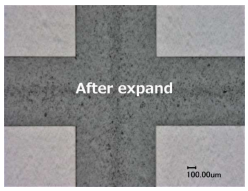



<< Single crystals >>

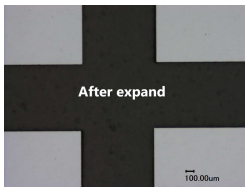
Material	SiC
Thickness	t0.35 mm
Substrate size	2 inch
Chip size	□5x5 mm

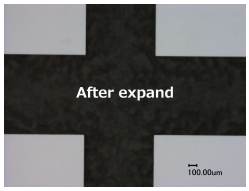
Material	Sapphire
Thickness	t0.2 mm
Substrate size	2 inch
Chip size	□5x5 mm

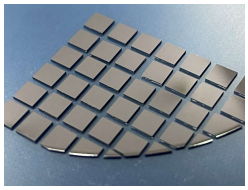
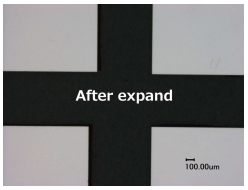
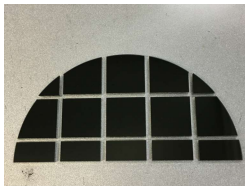
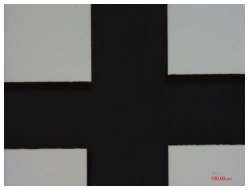
Material	Si (100)
Thickness	t0.5 mm
Substrate size	4 inch
Chip size	□10x10 mm



Material	GaAs
Thickness	t0.6 mm
Chip size	□5x5 mm



Material	InP
Thickness	t0.4 mm
Chip size	□3x3 mm




Material	Ge (111)
Thickness	t1.0 mm
Chip size	□10x10 mm